

FUTURE UDIMM DDR4

Introduction

HIKSEMI memory module FUTURE UDIMM is a DDR4 memory module, which is made of high-quality DRAM chips and mature production technology, which makes it more compatible, stable and cost-effective. Can be widely used in PC installations, various high-bandwidth, high-performance system applications.



Features

- Cost-effective
Adopt selected IC to make the system run stably and perform better.
- Good compatibility
Better compatibility, compatible with more products after HIKSEMI optimization.

Ordering Information

Frequency	Capacity	Model
3200MHz	8GB	HSC408U32C2
	16GB	HSC416U32C2
	32GB	HSC432U32C2
3600MHz	8GB	HSC408U36C2
	16GB	HSC416U36C2
	32GB	HSC432U36C2
4000MHz	8GB	HSC408U40C2
	16GB	HSC416U40C2
	32GB	HSC432U40C2

Note

Please contact the local sales for detailed model information.

Specification

Name	FUTURE UDIMM DDR4		
Capacity	8GB	16GB	32GB
Interface	DDR4		
frequency	3200/3600/4000MHz		
Pin	288pin		
PCB Size(L×W×H mm)	133.25*31.25*1.4		
Operation temperature	0 °C to 85 °C (32 °F to 185 °F)		
Limited warranty period	Lifetime warranty		
Weight	70g		

Revision History

Version	Description	Date
V1.0.0	FUTURE UDIMM DDR4	20240410

Data subject to change without notice.

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The Manual includes instructions for using and managing the Product. Pictures, charts, images and all other information hereinafter are for description and explanation only. The information contained in the Manual is subject to change, without notice, due to firmware updates or other reasons. Please find the latest version of this Manual at the HIKSTORAGE website (www.hiksemitech.com).